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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

CHAD A. COBBLEY
TONGBI JIANG
ED A. SCHROCK

Serial No. 08/916,629

Art Unit: 1733

Filing Date: AUGUST 22, 1997

Examiner: Aftergut, J.H.

For: SEMICONDUCTOR DIE ATTACHMENT
METHOD AND APPARATUS

Attorney Docket No. 97-0098

AMENDMENT

December 24, 2003

Mail Stop Non Fee Amendment
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This Amendment is in response to the Office Action dated 09/24/2003 having a statutory period for response set to expire on 12/24/2003. Please amend the case as follows.